$ASSEMBLY\\TECHNOLOGIES$



PPI-Time Zero is committed to through-hole technology and offers premier service and top quality workmanship. Using the most advanced surface mount technology, we deliver complex assemblies to satisfy a wide range of applications.

TO SATISFY CUSTOMERS' requirements and exceed industry demands, PPI-Time Zero continues to add and upgrade services and support initiatives that will enhance our position to better serve our markets. Our effort to focus on customer and supplier partnerships is in response to market-place demands for superior products and performance.

FULL-SERVICE CEM SERVICES

- Materials Procurement and Management
- PCB Assembly
- In-circuit, Combination and Functional Testing
- Systems Integration / Box-Build / Test
- Dock-to-Stock Distribution
- Repair / Warranty Service Management
- End-of-Life Support

LEADING EDGE MANUFACTURING

- High I/O, Ball Grid Array, Column Grid Array
- Direct Chip Attach
- Chip Scale Packaging
- Fine / Ultra Fine Pitch QFP
- 0402 Chip Devices
- PCIMA
- Pin-in-Paste Soldering
- Quick-Turn Services
- Systems Integration / Box Build
- High / Medium / Low Volume Production
- Support / Repair / Warranty Depot
- Warehousing

THROUGH-HOLE TECHNOLOGY

- Specialization in through-hole manufacturing
- Commitment to the technology
- Premier service and top-quality workmanship
- Thirty years experience in through-hole
- Highly trained, customer-focused work force
- State-of-the-art equipment

SURFACE MOUNT TECHNOLOGY

- Capacity to a wide range of applications
- Cost-effective innovations for maximum performance
- High-mix, low-to-medium volume runs
- State-of-the-art equipment
- High quality, fast turnaround



